

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT7185622

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ROBERT FU	05/27/2004
TIEN-MIN CHEN	05/26/2004
RECEIVING PARTY DATA	
Name:	TRANSMETA CORPORATION
Street Address:	3990 FREEDOM CIRCLE
City:	SANTA CLARA
State/Country:	CALIFORNIA
Postal Code:	95054
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12628010
CORRESPONDENCE DATA	
Fax Number:	
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	8019803399
Email:	FBparalegal@maxval.com
Correspondent Name:	FISHERBROYLES, LLP - FACEBOOK, INC
Address Line 1:	222 SOUTH MAIN STREET, 5TH FLOOR
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ATTORNEY DOCKET NUMBER:	007726.0740U24
NAME OF SUBMITTER:	JONATHAN LEE
SIGNATURE:	/Jonathan Lee/
DATE SIGNED:	02/19/2022
Total Attachments: 2	
source=Inventor to Transmeta Corporation#page2.tif	
source=Inventor to Transmeta Corporation#page3.tif	

Attorney Docket No.: TRAN-P196

Assignment to TRANSMETA Corporation

In consideration of good and valuable consideration, receipt of which is hereby acknowledged, I/we
Robert Fu

do hereby sell, assign, and transfer unto Transmeta Corporation (hereinafter called Transmeta), a Delaware Corporation having its principal place of business at 3990 Freedom Circle, Santa Clara, CA 95054, and its successors and assigns, the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements, including the right of priority in, to, and under, the application for the United States patent entitled:

SYSTEM FOR SUBSTRATE POTENTIAL REGULATION DURING POWER-UP IN INTEGRATED CIRCUITS

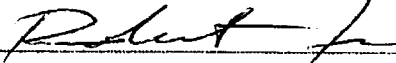
filed herewith and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefor; or

Serial No.: 10/712,523 filed on 11/12/03 and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefor;

And for the above consideration, I/we agree promptly upon request of Transmeta, its successors or assigns, to execute and deliver without further compensation any power of attorney, assignment, application, whether original, continuation, divisional or reissue, or other papers which may be necessary or desirable fully to secure to Transmeta, its successors and assigns, the inventions described in said application and all patent rights therein, in the United States and in any country foreign thereto, and to cooperate and assist in the prosecution of interference proceedings involving said inventions and in the adjudication or reexamination of said Letters Patent provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by Transmeta.

I/we further covenant with Transmeta, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned;

In witness whereof, I/we hereunto set my/our hand(s) and seal:

Inventor's Signature:  Date: 5/27/04

Assignment to TRANSMETA Corporation

In consideration of good and valuable consideration, receipt of which is hereby acknowledged, I/we
Tien-Min Chen

do hereby sell, assign, and transfer unto Transmeta Corporation (hereinafter called Transmeta), a Delaware Corporation having its principal place of business at 3990 Freedom Circle, Santa Clara, CA 95054, and its successors and assigns, the entire right, title, and interest for the United States and all foreign countries, in and to any and all improvements, including the right of priority in, to, and under, the application for the United States patent entitled:

SYSTEM FOR SUBSTRATE POTENTIAL REGULATION DURING POWER-UP IN INTEGRATED CIRCUITS

filed herewith and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefor; or

X Serial No.: 10/712,523 filed on 11/12/03 and the inventions set forth and described therein, and any and all Letters Patent of the United States and of countries foreign thereto which may be granted thereon or therefor;

And for the above consideration, I/we agree promptly upon request of Transmeta, its successors or assigns, to execute and deliver without further compensation any power of attorney, assignment, application, whether original, continuation, divisional or reissue, or other papers which may be necessary or desirable fully to secure to Transmeta, its successors and assigns, the inventions described in said application and all patent rights therein, in the United States and in any country foreign thereto, and to cooperate and assist in the prosecution of interference proceedings involving said inventions and in the adjudication or reexamination of said Letters Patent provided the expenses which may be incurred by me/us in lending such cooperation and assistance are paid by Transmeta.

I/we further covenant with Transmeta, its successors, assigns, and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned;

In witness whereof, I/we hereunto set my/our hand(s) and seal:

Inventor's Signature: Tien-Min Chen Date: 05/26/04